

# United States Patent and Trademark Office

UNITED STATES DEPARTMENT OF COMMERCE United States Patent and Trademark Office Address: COMMISSIONER FOR PATENTS P.O. Box 1450 Alexandria, Virginia 22313-1450 www.uspto.gov

DATE MAILED: 03/16/2006

APPLICATION NO. FI	LING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.		
10/760,995	01/20/2004	Kuo-Chin Liu	252011-1890	1640		
47390 7590	03/16/2006		EXAM	INER		
THOMAS, KAYDEN, HOSTEMEYER & RISLEY LLP			NGUYEN,	NGUYEN, THANH T		
100 GALLERIA PARI SUITE 1750	KWAY	•	ART UNIT	PAPER NUMBER		
ATLANTA, GA 303	39	,	2813			

Please find below and/or attached an Office communication concerning this application or proceeding.

		Application No.	Applicant(s)	10,		
Office Action Summary		10/760,995	LIU ET AL.			
		Examiner	Art Unit			
		Thanh T. Nguyen	2813			
Period fo	The MAILING DATE of this communication or Reply	appears on the cover sheet	with the correspondence address	is		
THE - Exte after - If the - If NO - Failt Any	ORTENED STATUTORY PERIOD FOR RE MAILING DATE OF THIS COMMUNICATIOnsions of time may be available under the provisions of 37 CF SIX (6) MONTHS from the mailing date of this communication e period for reply specified above is less than thirty (30) days, and period for reply is specified above, the maximum statutory period for reply within the set or extended period for reply will, by significantly received by the Office later than three months after the new patent term adjustment. See 37 CFR 1.704(b).	N. R 1.136(a). In no event, however, may b. a reply within the statutory minimum of striod will apply and will expire SIX (6) Matute, cause the application to become	a reply be timely filed thirty (30) days will be considered timely. ONTHS from the mailing date of this community (35 U.S.C. § 133).	inication.		
Status						
1) 又	Responsive to communication(s) filed on 1	0 January 2006.				
•		This action is non-final.				
3)	<del>'</del>					
Disposit	ion of Claims					
4)⊠ 5)⊠ 6)⊠ 7)⊠	Claim(s) <u>1-23</u> is/are pending in the applica 4a) Of the above claim(s) is/are with Claim(s) <u>11-23</u> is/are allowed. Claim(s) <u>1-6,8 and 9</u> is/are rejected. Claim(s) <u>7 and 10</u> is/are objected to. Claim(s) are subject to restriction are	drawn from consideration.				
Applicat	ion Papers					
9)[	The specification is objected to by the Exar	niner.				
10)	The drawing(s) filed on $\_$ is/are: a) $\square$			•		
	Applicant may not request that any objection to					
11)	Replacement drawing sheet(s) including the co The oath or declaration is objected to by the					
Priority	under 35 U.S.C. § 119					
a)	Acknowledgment is made of a claim for force  All b) Some * c) None of:  1. Certified copies of the priority docum  2. Certified copies of the priority docum  3. Copies of the certified copies of the application from the International Buse the attached detailed Office action for a	nents have been received. nents have been received ir priority documents have be reau (PCT Rule 17.2(a)).	n Application No en received in this National Sta	ge		
Attachmer	nt(s)	_				
	ce of References Cited (PTO-892)		w Summary (PTO-413) No(s)/Mail Date			
3) Info	ce of Draftsperson's Patent Drawing Review (PTO-948 mation Disclosure Statement(s) (PTO-1449 or PTO/Ster No(s)/Mail Date	′	of Informal Patent Application (PTO-15	2)		

## Page 2

#### **DETAILED ACTION**

#### Request for Continued Examination

The request filed on 1/10/06 for a Request for Continued Examination (RCE) under 37 CFR 1.114 is acceptable and an RCE has been established. An action on the RCE follows.

## Claim Rejections - 35 USC § 102

The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

(e) the invention was described in (1) an application for patent, published under section 122(b), by another filed in the United States before the invention by the applicant for patent or (2) a patent granted on an application for patent by another filed in the United States before the invention by the applicant for patent, except that an international application filed under the treaty defined in section 351(a) shall have the effects for purposes of this subsection of an application filed in the United States only if the international application designated the United States and was published under Article 21(2) of such treaty in the English language.

Claims 1-2, 5, 8 are rejected under 35 U.S.C. 102(e) as being anticipated by Wang et al. (U.S. Patent Publication No. 2004/0074869).

Referring to figures 1-3, Wang et al. teaches a semiconductor process for controlling etching profile, comprising the steps of:

providing a plurality of substrates, wherein each substrate comprises a film to be etched and an overlying masking pattern layer (26, photomask) thereon (see figures 1); and

etching the film to be etched on each substrate in a plasma chamber using the masking pattern layer as an etch mask, a polymer layer being deposited over the inner wall of the plasma chamber during the etching (see figure 2, paragraph# 22, 55);

wherein an intermediary cleaning process is performed in the plasma chamber between the etchings before the deposited polymer layer reaches such a degree as to induce lateral etching (see paragraph# 38, 40) on the film to be etched of the next substrate (see figure 1, paragraph# 22, 26, 52, 55).

Regarding to claim 2. the film to be etched is a silicon layer (22/24, see figure 1a, silicon-oxynitride).

Regarding to claim 5, intermediary cleaning process is performed between each of the etchings (see figure 2, paragraph# 22, 26, 52, 55).

Regarding to claim 8, performing a preliminary cleaning process in the plasma chamber before placing the substrates therein (figure 2-3, paragraph# 46).

## Claim Rejections - 35 USC § 103

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

Claim 4 is stand rejected under 35 U.S.C. 103(a) as being unpatentable over Wang et al. (U.S. Patent Publication No. 2004/0074869) as applied to claims 1-2, 5, and 8, above, in view of Qian et al. (U.S. Patent No. 5,599,399).

Wang et al. teaches a method cleaning a semiconductor process for controlling etching profile. However, Wang et al. does not teach masking layer composed of silicon oxide.

Qian et al. teaches the mask layer composed of silicon oxide or photoresist (see col. 9, lines 59-61).

Therefore, it would have been obvious to a person of ordinary skill in the requisite art at the time of the invention was made would forming a mask layer by silicon oxide instead of photoresist in process of Wang et al. as taught by Qian et al. because the process is known in the semiconductor process for pattern a layer during etch to protect the underlying film.

Claims 3, 6, 9 are rejected under 35 U.S.C. 103(a) as being unpatentable over Wang et al. (U.S. Patent Publication No. 2004/0074869) as applied to claims 1-2, 5, and 8, above, in view of Zhong et al. (U.S. Patent No. 6,124,927).

Wang et al. teaches a method cleaning a semiconductor process for controlling etching profile. However, Wang et al. does not teach the intermediary cleaning process is performed before the deposited polymer layer leads to a spectral intensity associated with the layer to be etched from OES data analysis more than 100 at a wavelength about 405 nm (claim 3), the mask layer is a silicon oxide layer (claim 4), intermediary cleaning process is performed for 1-3 minutes (claim 6), preliminary cleaning process is performed for 8-12 minutes (claim 9).

Art Unit: 2813

Zhong et al. teaches a method for control plasma cleaning process by monitoring the optical emission of the plasma wherein cleaning process is performed before the deposited polymer layer leads to a spectral intensity associated with the layer to be etched from OES data analysis more than 100 at a wavelength about 405 nm (see col. 4, lines 6-47, meeting claim 3).

Therefore, it would have been obvious to a person of ordinary skill in the requisite art the time of the invention was made would control plasma cleaning process by monitoring the optical emission of the plasma wherein cleaning process is performed before the deposited polymer layer leads to a spectral intensity associated with the layer to be etched from OES data analysis more than 100 at a wavelength about 405 nm in process of Wang et al. as taught by Zhong et al. because the process would help to identified the endpoint fro the cleaning cycle.

It would have been obvious to a person of ordinary skill in the requisite art at the time of the invention was made to optimize the time range for the cleaning process, since it has been held that where the general conditions of a claim are disclosed in the prior art (i.e.-cleaning process), discovering the optimum or workable ranges involves only routine skill in the art. In re Aller, 105 USPQ 233 (CCPA 1955).

The specification contains no disclosure of either the critical nature of the claimed arrangement (i.e.- wherein cleaning process is performed for 1-3 minutes or 8-12 minutes) or any unexpected results arising therefrom. Where patentability is said to be based upon particular chosen limitations or upon another variable recited in a claim, the applicant must show that the chosen limitations are critical. In re Woodruff, 919 F.2d 1575, 1578 (FED. Cir. 1990).

The time range of the cleaning process are considered to involve routine optimization while has been held to be within the level of ordinary skill in the art. As noted in In re Aller, the

Art Unit: 2813

selection of reaction parameters such as temperature and concentration would have been obvious:

Normally, it is to be expected that a change in temperature, or in concentration, or in both, would be an unpatentable modification. Under some circumstances, however, changes such as these may impart patentability to a process if the particular ranges claimed produce a new and unexpected result which is different in kind and not merely degree from the results of the prior art...such ranges are termed Acritical ranges and the applicant has the burden of proving such criticality.... More particularly, where the general conditions of a claim are disclosed in the prior art, it is not inventive to discover the optimum or workable ranges by routine experimentation.

In re Aller 105 USPQ233, 255 (CCPA 1955). See also In re Waite 77 USPQ 586 (CCPA 1948); In re Scherl 70 USPQ 204 (CCPA 1946); In re Irmscher 66 USPQ 314 (CCPA 1945); In re Norman 66 USPQ 308 (CCPA 1945); In re Swenson 56 USPQ 372 (CCPA

1942); In re Sola 25 USPQ 433 (CCPA 1935); In re Dreyfus 24 USPQ 52 (CCPA 1934).

Therefore, one of ordinary skill in the requisite art at the time the invention was made would have used any time range suitable to the method in process of Wang et al. in order to optimize the process.

### Allowable Subject Matter

Claims 7, 10 are objected to as being dependent upon a rejected base claim, but would be allowable if rewritten in independent form including all of the limitations of the base claim and any intervening claims. because none of the prior art alone or in combination teaches or suggests the particular subset of the process steps intermediary cleaning comprises the steps of: using O<sub>2</sub>, Cl<sub>2</sub> and SF<sub>6</sub> as a first cleaning gas for about 30 second, and using Cl<sub>2</sub>, and HBr as a second cleaning gas for about 50 seconds.

Claims 11-23 are allowed over the prior art because none of the prior art alone or in combination teaches or suggests the particular subset of the process steps in forming a capping

Art Unit: 2813

layer with a bird's beak overlying the polysilicon layer, and etching each of the polysilicon layers in sequence in a plasma chamber using the overlying capping layer as an etch mask to form a floating gate on each of the floating gate dielectric layers, a polymer layer being deposited over the inner wall of the plasma chamber during the etching, wherein an intermediary cleaning process is performed in the plasma chamber between the etchings before the deposited polymer layer reaches such a degree as to induce lateral etching on the next polysilicon layer.

#### Conclusion

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Thanh Nguyen whose telephone number is (571) 272-1695, or by Email via address Thanh.Nguyen@uspto.gov. The examiner can normally be reached on Monday-Thursday from 6:00AM to 3:30PM.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Carl Whitehead, Jr., can be reached on (571) 272-1702. The fax phone number for this Group is (703) 872-9306.

Any inquiry of a general nature or relating to the status of this application or proceeding should be directed to the Group receptionist whose telephone number is (703) 308-0956 (See MPEP 203.08).

> Thanh Nguyen Patent Examiner

Patent Examining Group 2800